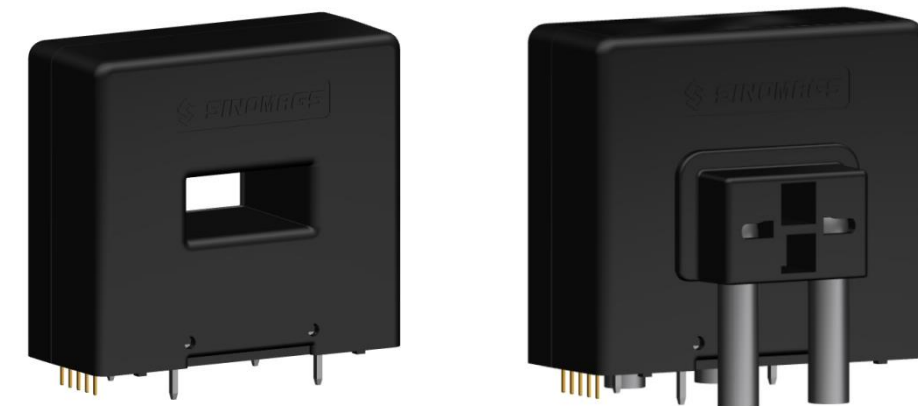


CURRENT SENSOR

PRODUCT SERIES: STB-300LA

PRODUCT PART NUMBER: STB-300LA/M
STB-300LA/ML

VERSION: Ver2.2



Sinomags Technology Co., Ltd.

Web site: www.sinomags.com

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1. Description

STB-300LA/M series current sensors are based on close loop principle with TMR technology. The sensor can detect the current with DC, AC, pulse and irregular wave shape.

Typical application

- Solar inverter
- Direct-current dynamo
- Uninterruptible Power Supplies (UPS)
- Switched model power supplies (SMPS)
- Variable frequency converter

General parameters

Parameter	Symbol	Unit	Value	Remark
Working temperature	T_A	°C	-40 ~ 105	105°C, I _{max} =530A
Storage temperature	T_stg	°C	-40 ~ 105	
Mass	m	g	115/160	STB-300LA/M& STB-300LA/ML
ROHS	/	/	conform	
MSL	/	/	1	

Absolute parameters

Parameters	Symbol	Unit	Value
Supply voltage	V _{cc_max}	V	6
Maximum primary current	I _{p_max}	A	10*I _{pn}
ESD rating (HBM)	U_ESD_HBM	kV	4
High temperature and humidity	T_HAST	-	85°C&85%RH (1000h)

Remark: the unrecoverable damage may occur when the product works on the conditions over the absolute maximum ratings. Long-time working on the absolute maximum ratings may cause the degradation on performance and reliability.

Isolation parameters

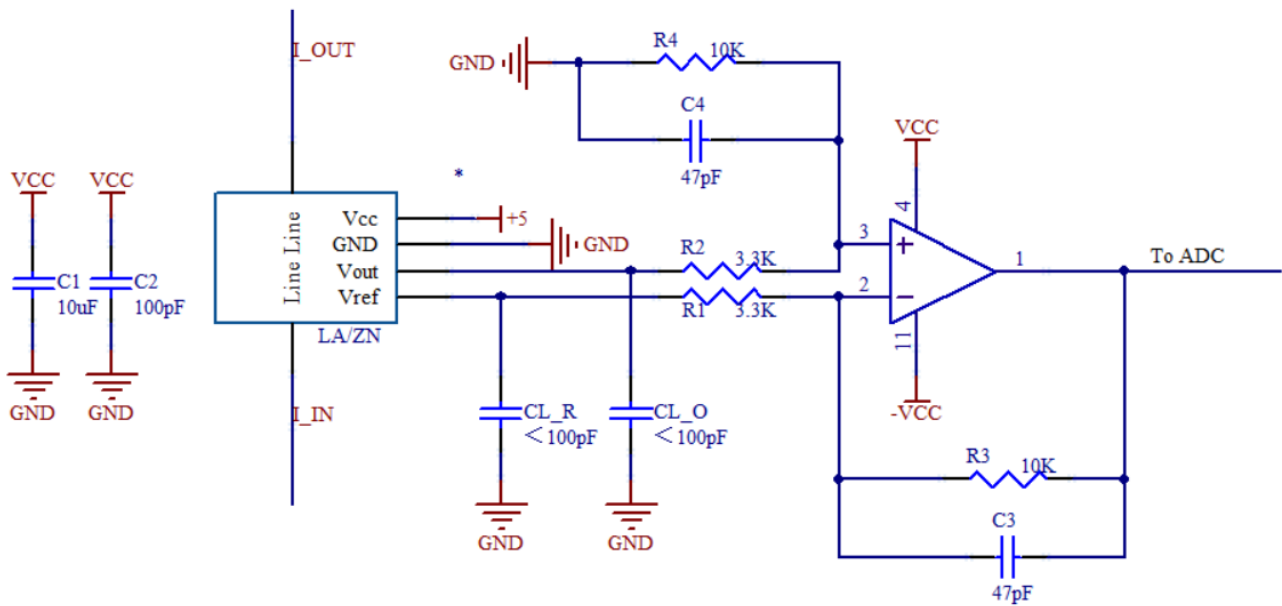
Parameter	Symbol	Unit	Value	Remark
RMS voltage for AC test 50Hz/1 min	U _d	kV	4	
Impulse withstand voltage 1.2/50μs	Ū _w	kV	8	
Case material			V0	According to UL 94
Comparative tracking index	CTI	V	600	

2. Electrical parameters (STB-300LA/M&STB-300LA/ML)

Condition: Vcc = 5.0 V, RL = 10 kΩ, T A = 25°C, unless specified.

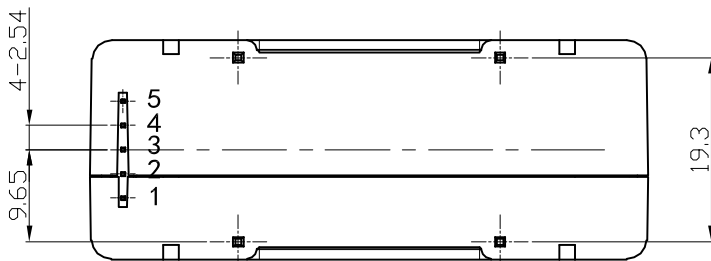
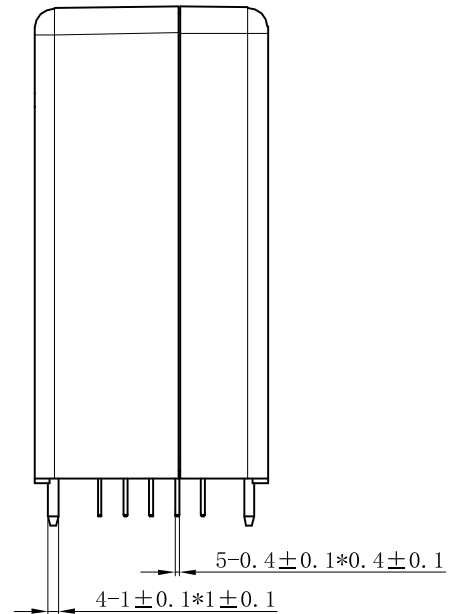
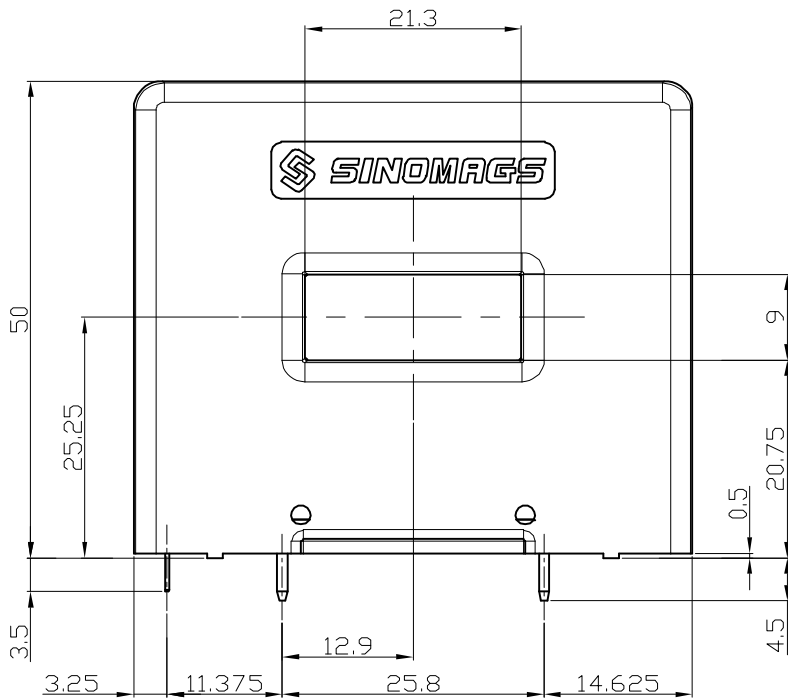
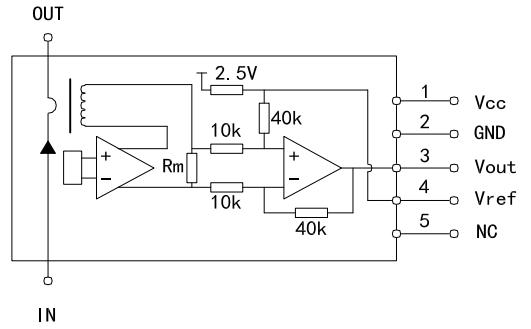
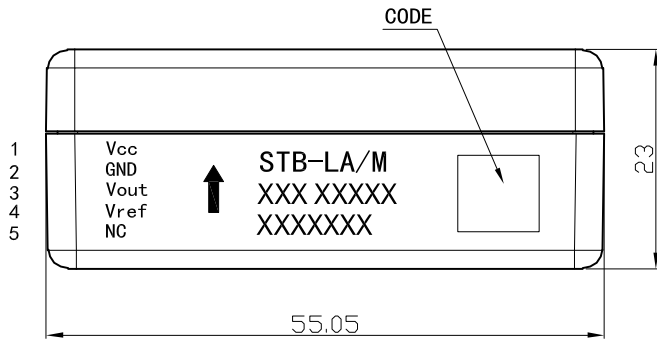
Parameters	Symb ol	Unit	Min.	Typ.	Max.	Remark
Primary nominal rms current	I _{pn}	A		300		
Primary current measuring range	I _{pm}	A	-600		600	
Maximum measured peak overcurrent (transformer effect)	îP meas	A	-750		750	duration at 750 A is 400us
Supply voltage	Vcc	V	4.75	5	5.25	
Consumption current	Ic	mA	10 + I _p /NS*1000			NS = 1875
Reference voltage	V _{ref}	V	2.48	2.5	2.52	
Electrical offset voltage	V _{oe}	mV		5		100 % tested (V _{out} – V _{ref})@ 0 A
Magnetic offset current	I _{om}	mA	100		100	@6*I _{pn}
Full-scale voltage	V _{fs}	V		± 0.9375		(V _{out} – V _{ref})@ I _{pn}
Theoretical sensitivity	G _{th}	mV/A		3.125		0.9375 V @ I _{pn}
Sensitivity error	G _{err}	% of I _{pn}	-0.8		0.8	
Linearity error within I _{pn}	ξ _L	% of I _{pn}	-0.15		0.15	@25°C
Reaction time @ 10 % of I _p	t _{ra}	µs		0.6		
Step response time @ 90 % of I _p	t _r	µs		0.6		
-3 dB band width	BW	kHz		300		
Noise DC ~ 10 kHz DC ~ 100 kHz	Vnois e	mV pp		5 6		
Accuracy @ 25°C	X	% of I _{pn}	-0.8		0.8	
Accuracy @ 85 °C	X _{TR} ange	% of I _{pn}	-1.1		1.1	
Vout Capacitive Load	CL _O	pF	0		100	
Vref Capacitive Load	CL _R	pF	0		100	

3. Typical application circuits



Typical application circuits for STB-LA current sensor. The magnification can be estimated as $M = R4 / R2$ with the condition of $R1 = R2$, and $R3 = R4$. The magnification in the circuit above is around 3. The capacitive load of Vout and Vref should not exceed 100pF to avoid oscillations.

4. Dimensions: STB-300LA/M

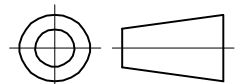


Terminals

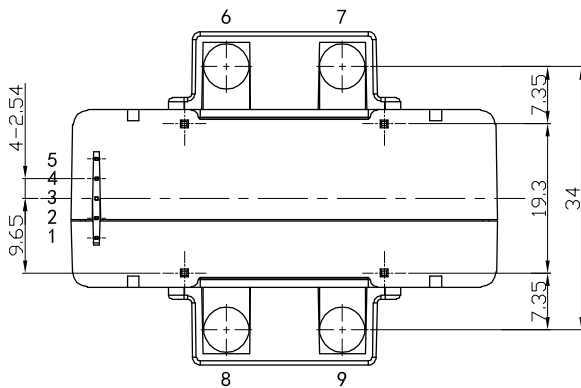
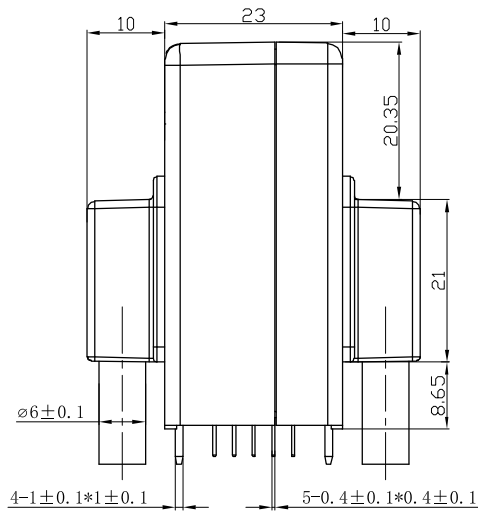
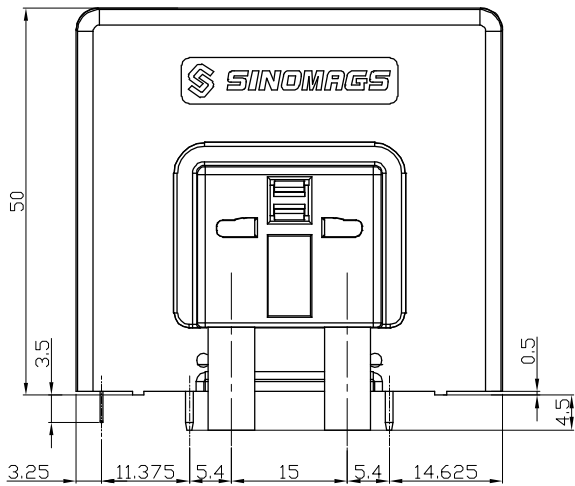
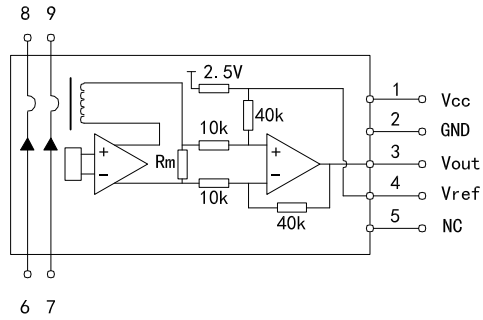
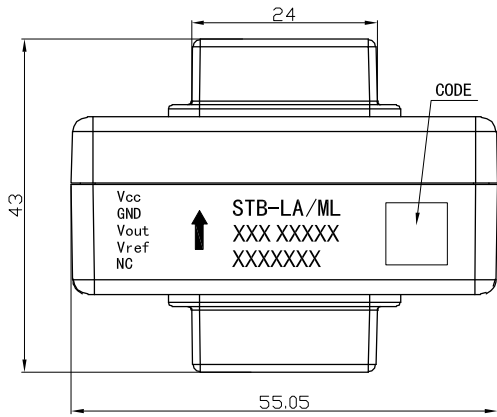
(1)	Vcc
(2)	GND
(3)	Vout
(4)	Vref
(5)	NC

Material : Fit UL94V-0 & RoHS requirements ;
General tolerance : ±0.5

Unit : mm



5. Dimensions: STB-300LA/ML



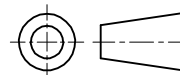
Terminals

1	Vcc	6	Ip+
2	GND	7	Ip+
3	Vout	8	Ip-
4	Vref	9	Ip-
5	NC		

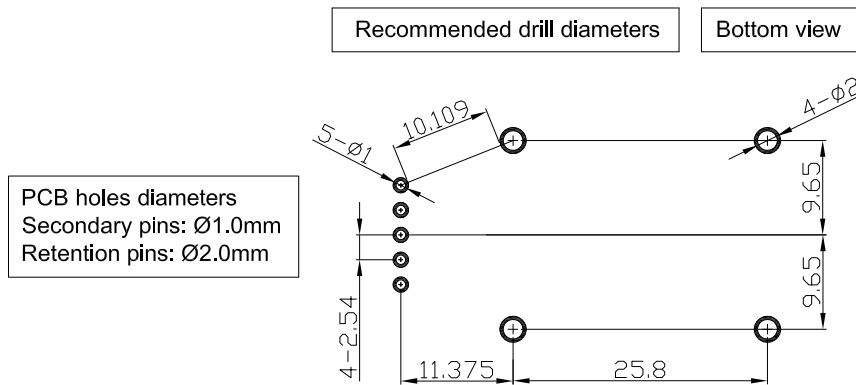
Material : Fit UL94V-0 & RoHS requirements ;

General tolerance : ± 0.5

Unit :mm



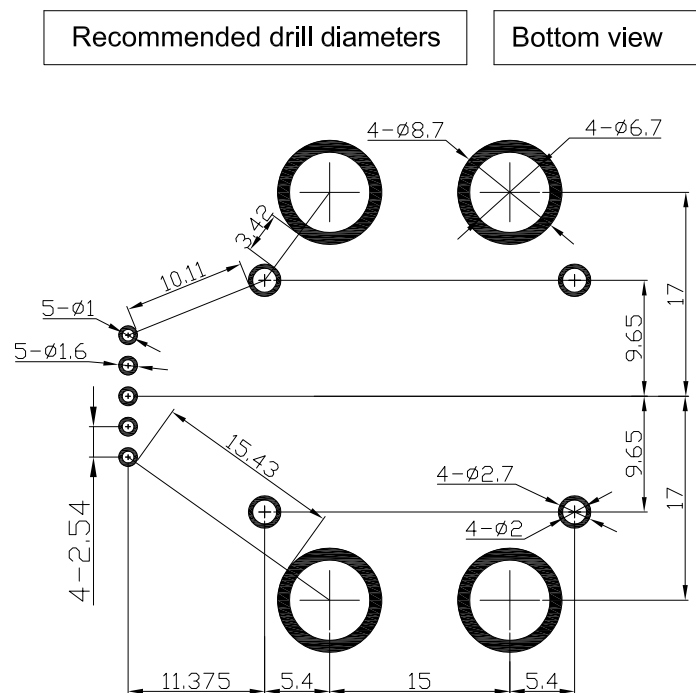
6. PCB footprint (STB-300LA/M)



Assembly on PCB

- Recommended PCB hole diameter: 1 mm for secondary pins, 2 mm for retention pin.
- Maximum PCB thickness: 2.4 mm (can be customized per request).
- Wave soldering profile: maximum 270°C for 10 seconds.

7. PCB footprint (STB-300LA/ML)



Assembly on PCB

- Recommended PCB hole diameter: 1 mm for secondary pins, 2 mm for retention pin.
- Maximum PCB thickness: 2.4 mm (can be customized per request).
- Wave soldering profile: maximum 270°C for 10 seconds.